506371205 11/24/2020

PATENT ASSIGNMENT COVER SHEET

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EPAS ID: PAT6417961

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
RICHARD ROCHFORD	11/24/2020
EDWARD L. BRABANT JR	11/18/2020

RECEIVING PARTY DATA

Name:	BAE Systems Information and Electronic Systems Integration Inc.	
Street Address:	PO Box 868	
Internal Address:	NHQ1-719	
City:	Nashua	
State/Country:	NEW HAMPSHIRE	
Postal Code:	03061-0868	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	29759675

CORRESPONDENCE DATA

Fax Number: (603)885-2167

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 603-885-6680

Email: nancy.young@baesystems.com

NANCY YOUNG **Correspondent Name:**

Address Line 1: 65 SPIT BROOK ROAD

Address Line 2: NHQ01-719

Address Line 4: NASHUA, NEW HAMPSHIRE 03060

ATTORNEY DOCKET NUMBER:	20-4567DES
NAME OF SUBMITTER:	NANCY A. YOUNG
SIGNATURE:	/Nancy A. Young/
DATE SIGNED:	11/24/2020
	This document serves as an Oath/Declaration (37 CFR 1.63).

Total Attachments: 4

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COMBINED DECLARATION AND ASSIGNMENT OF INVENTION

As below named inventor(s), I hereby declare that this Declaration and Assignment is directed to:

CLIP FOR SECURELY TRANSPORTING AND HANDLING A SEMICONDUCTOR CHIP TRAY

ney/agent to
]

The referenced application was made or authorized to be made by me and I believe that I am the original or joint inventor of the claimed invention in the application. I hereby acknowledge that any willful false statement made in this declaration are punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

I have reviewed and understand the contents of the referenced application including the claims, as amended by any amendment referenced herein. I acknowledge the duty to disclose information which is material to patentability of this application as defined in 37 CFR 1.56.

In accordance with my obligation(s) under the Proprietary Information and Assignment of Inventions Agreement or (as applicable) arising out of other agreements, and/or for other good and valuable consideration of which receipt is acknowledged, to **BAE Systems Information And Electronic Systems Integration Inc.** (hereinafter referred to as BAE), a Delaware corporation, having a place of business at PO Box 868, Nashua, New Hampshire, 03061-0868, I hereby sell, assign and transfer to BAE its successors, and assigns my entire right, title and interest, including the right of priority, in, and to the invention and improvements made in any and all applications, both United States and foreign, continuations, continuations-in-part (CIPs), divisionals, and renewals of and substitutes for said application for said Letters Patent, and any and all Letters Patent of the United States and of countries foreign thereto including the right of priority under the International Convention which may be granted thereon or therefore; and any reissues, or reexaminations, or extensions of said Letters Patent.

I additionally authorize BAE to file applications in my name for Letters Patent in any country, to be held and enjoyed by BAE, its successors, assigns, nominees or legal representatives, to the full end of the term or terms for which said Letters Patent respectively may be granted, reissued or extended, as fully and entirely as the same would have been held and enjoyed by me/us had this assignment, and transfer not been made;

And I/we hereby covenant that I/we have a full right to convey my/our entire interest herein assigned, and that I/we have not executed and will not execute any agreement in conflict herewith, and I/we further covenant and agree that I/we will, each time a request is made, and without undue delay, execute and deliver all such papers as may be necessary or desirable to perfect the title to said invention(s) or improvement(s), said application and said Letters Patent to BAE, its successors, assigns, nominees or legal representatives, and I/we agree to communicate to BAE, or to its nominee, all known facts respecting said invention(s) or improvement(s) said application and said Letters Patent, to testify in any legal proceedings, to sign all lawful papers, to execute all disclaimers and divisionals, continuations, CIPs, reissue and foreign applications, to make all rightful oaths and declarations, and generally to do everything reasonable to aid BAE, its successors, assigns, nominees and legal representatives to obtain and enforce, for its or their own benefit, proper patent protection for said invention(s) or improvements(s) in any and all countries;

And I/we hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any country or countries foreign to the United States whose duty it is to issue patents on applications as aforesaid, to issue to BAE, as assignee of my/our entire right, title and interest, any and all Letters Patent for said invention(s) or improvement(s), including any and all Letters Patent of the United States which may be issued and granted on or as a result of the application aforesaid, in accordance with the terms of this Assignment;

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Date:	11/24/2020	/Richard Rochford/	
		Richard Rochford	
Date:			
		Edward L. Brahant Ir	

COMBINED DECLARATION AND ASSIGNMENT OF INVENTION

As below named inventor(s), I hereby declare that this Declaration and Assignment is directed to:

CLIP FOR SECURELY TRANSPORTING AND HANDLING A SEMICONDUCTOR CHIP TRAY

The application attached hereto	OR	
the United States application (pr	rovisional or non-provisional) or PCT internation	nal application:
Application Number:	Filed on:	
(As amended (if applicable) - an	nd we hereby request and authorize the Company	or its delegated attorney/agent to
insert above the application num	ber and file date of the application when known.	.)

The referenced application was made or authorized to be made by me and I believe that I am the original or joint inventor of the claimed invention in the application. I hereby acknowledge that any willful false statement made in this declaration are punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

I have reviewed and understand the contents of the referenced application including the claims, as amended by any amendment referenced herein. I acknowledge the duty to disclose information which is material to patentability of this application as defined in 37 CFR 1.56.

In accordance with my obligation(s) under the Proprietary Information and Assignment of Inventions Agreement or (as applicable) arising out of other agreements, and/or for other good and valuable consideration of which receipt is acknowledged, to **BAE Systems Information And Electronic Systems Integration Inc.** (hereinafter referred to as BAE), a Delaware corporation, having a place of business at PO Box 868, Nashua, New Hampshire, 03061-0868, I hereby sell, assign and transfer to BAE its successors, and assigns my entire right, title and interest, including the right of priority, in, and to the invention and improvements made in any and all applications, both United States and foreign, continuations, continuations-in-part (CIPs), divisionals, and renewals of and substitutes for said application for said Letters Patent, and any and all Letters Patent of the United States and of countries foreign thereto including the right of priority under the International Convention which may be granted thereon or therefore; and any reissues, or reexaminations, or extensions of said Letters Patent.

I additionally authorize BAE to file applications in my name for Letters Patent in any country, to be held and enjoyed by BAE, its successors, assigns, nominees or legal representatives, to the full end of the term or terms for which said Letters Patent respectively may be granted, reissued or extended, as fully and entirely as the same would have been held and enjoyed by me/us had this assignment, and transfer not been made;

And I/we hereby covenant that I/we have a full right to convey my/our entire interest herein assigned, and that I/we have not executed and will not execute any agreement in conflict herewith, and I/we further covenant and agree that I/we will, each time a request is made, and without undue delay, execute and deliver all such papers as may be necessary or desirable to perfect the title to said invention(s) or improvement(s), said application and said Letters Patent to BAE, its successors, assigns, nominees or legal representatives, and I/we agree to communicate to BAE, or to its nominee, all known facts respecting said invention(s) or improvement(s) said application and said Letters Patent, to testify in any legal proceedings, to sign all lawful papers, to execute all disclaimers and divisionals, continuations, CIPs, reissue and foreign applications, to make all rightful oaths and declarations, and generally to do everything reasonable to aid BAE, its successors, assigns, nominees and legal representatives to obtain and enforce, for its or their own benefit, proper patent protection for said invention(s) or improvements(s) in any and all countries;

And I/we hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any country or countries foreign to the United States whose duty it is to issue patents on applications as aforesaid, to issue to BAE, as assignee of my/our entire right, title and interest, any and all Letters Patent for said invention(s) or improvement(s), including any and all Letters Patent of the United States which may be issued and granted on or as a result of the application aforesaid, in accordance with the terms of this Assignment;

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Date:		Richard Rochford	
Date:	11/18/2020	/Edward L Brabant Jr/_ Edward L. Brabant, Jr.	

PATENT REEL: 054461 FRAME: 0200

RECORDED: 11/24/2020